

#### HIGH PERFORMANCE FRACTIONAL-N SYNTHESIZER WITH INTEGRATED RF MIXER

Package: QFN, 32-Pin, 5mmx5mm

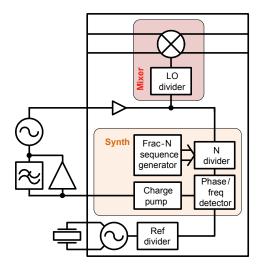


#### **Features**

- Fractional-N Synthesizer
- Very Fine Frequency Resolution 1.5 Hz for 26 MHz Reference
- 300 MHz to 2400 MHz External VCO Frequency Range
- On-Chip Crystal-Sustaining Circuit With Programmable Loading Capacitors
- Integrated LO Buffer and LO Divider
- High-Linearity RF Mixer
- Mixer Input IP3 +23dBm Typ.
- Mixer Bias Adjustable for Low Power Operation
- Mixer Frequency Range 30 MHz to 2500 MHz
- 2.7V to 3.6V Power Supply
- Low Current Consumption 50mA to 70mA at 3V
- 3-Wire Serial Interface

## **Applications**

- CATV Head-Ends
- Digital TV Up/Down Converters
- Digital TV Repeaters
- Multi-Dwelling Units
- Frequency Band Shifters
- UHF/VHF Radios
- Software Defined Radios
- Satellite Communications
- Super-Heterodyne Radios



Functional Block Diagram

#### **Product Description**

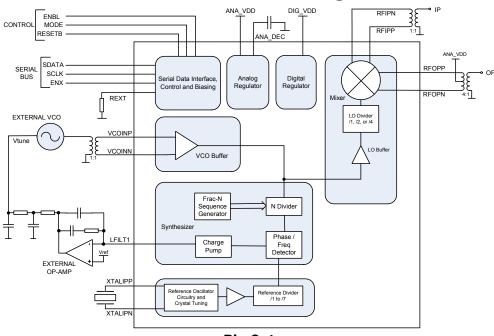
The RF2053 is a low power, high performance, wideband RF frequency conversion chip with integrated local oscillator (LO) generation and RF mixer. The RF synthesizer includes an integrated fractional-N phase locked loop that can control an external VCO to produce a low-phase noise LO signal with a very fine frequency resolution. The VCO output frequency can be divided by 1, 2, or 4 in the LO divider, whose output is buffered and drives the built-in RF mixer which converts the signal into the required frequency band. The mixer bias current can be programmed dependent on the required performance and available supply current. The LO generation blocks have been designed to operate with external VCOs covering the frequency range from 30MHz to 2400MHz. The RF mixer is very broad band and operates from 30MHz to 2500MHz at the input and output, enabling both up and down conversion. An external crystal of between 10MHz and 52MHz or an external reference source of between 10MHz and 104MHz can be used with the RF2053 to accommodate a variety of reference frequency options.

All on-chip registers are controlled through a simple three-wire serial interface. The RF2053 is designed for 2.7V to 3.6V operation for compatibility with portable, battery powered devices. It is available in a plastic 32-pin, 5 mmx5 mm QFN package.

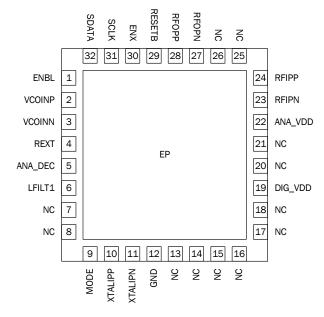
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|----------------|------------------|-------------------|------------|
| ☐ GaAs HBT     | ☐ SiGe BiCMOS    | ☐ GaAs pHEMT      | ☐ GaN HEMT |
| ☐ GaAs MESFET  | ☐ Si BiCMOS      | Si CMOS           | ☐ RF MEMS  |
| ☐ InGaP HBT    | ☐ SiGe HBT       | ☐ Si BJT          | ☐ LDMOS    |



## **Detailed Functional Block Diagram**



#### Pin Out





| Pin | Function    | Description   |
|-----|-------------|---|
| 1   | ENBL        | Ensure that the ENBL high voltage level is not greater than V <sub>DD</sub> . An RC low-pass filter could be used to reduce   |
|     |             | digital noise.  |
| 2   | VCOINP      | External VCO differential input. See note 1.  |
| 3   | VCOINN      | External VCO differential input. See note 1.  |
| 4   | REXT        | External bandgap bias resistor. Connect a $51 k\Omega$ resistor from this pin to ground to set the bandgap reference bias current. This could be a sensitive low frequency noise injection point. |
| 5   | ANA_DEC     | Analog supply decoupling capacitor. Connect to analog supply and apply RF decoupling to a good quality ground as close to the pin as possible.  |
| 6   | LFILT1      | Phase detector output. Low-frequency noise-sensitive node.  |
| 7   | NC          |   |
| 8   | NC          |   |
| 9   | MODE        | Mode select pin. Connect to DIG_VDD if mode switching is not required.  |
| 10  | XTALIPP     | Reference crystal / reference oscillator input. Should be AC-coupled if an external reference is used. See note 3.  |
| 11  | XTALIPN     | Reference crystal / reference oscillator input. Should be AC-coupled to ground if an external reference is used. See note 3.  |
| 12  | GND         | Connect to ground.  |
| 13  | NC          |   |
| 14  | NC          |   |
| 15  | NC          |   |
| 16  | NC          |   |
| 17  | NC          |   |
| 18  | NC          |   |
| 19  | DIG_VDD     | Digital supply. Should be decoupled as close to the pin as possible.  |
| 20  | NC          |   |
| 21  | NC          |   |
| 22  | ANA_VDD     | Analog supply. Should be decoupled as close to the pin as possible.   |
| 23  | RFIPN       | Differential input. See note 1.   |
| 24  | RFIPP       | Differential input. See note 1.   |
| 25  | NC          |   |
| 26  | NC          |   |
| 27  | RFOPN       | Differential output. See note 2.  |
| 28  | RFOPP       | Differential output. See note 2.  |
| 29  | RESETB      | Chip reset (active low). Connect to DIG_VDD if external reset is not required.  |
| 30  | ENX         | Serial interface select (active low). An RC low-pass filter could be used to reduce digital noise.  |
| 31  | SCLK        | Serial interface clock. An RC low-pass filter could be used to reduce digital noise.  |
| 32  | SDATA       | Serial interface data. An RC low-pass filter could be used to reduce digital noise.   |
| EP  | Exposed pad | Connect to ground. This is the ground reference for the circuit. All decoupling should be connected here through low impedance paths.   |

Note 1: The signal should be connected to this pin such that DC current cannot flow into or out of the chip, either by using AC coupling capacitors or by use of a transformer (see evaluation board schematic).

Note 2: DC current needs to flow from ANA\_VDD into this pin, either through an RF inductor, or transformer (see evaluation board schematic).

Note 3: Alternatively an external reference can be AC-coupled to pin 11 XTALIPN, and pin 10 XTALIPP decoupled to ground. This may make PCB routing simpler.



#### **Absolute Maximum Ratings**

| _   |                              |      |
|---|------------------------------|------|
| Parameter                                 | Rating                       | Unit |
| Supply Voltage (V <sub>DD</sub> )         | -0.5 to +3.6                 | V    |
| Input Voltage (V <sub>IN</sub> ), any Pin | -0.3 to V <sub>DD</sub> +0.3 | V    |
| RF/IF Mixer Input Power                   | +15                          | dBm  |
| Operating Temperature Range               | -40 to +85                   | °C   |
| Storage Temperature Range                 | -65 to +150                  | °C   |



#### Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EU Directive 2011/65/EU (at time of this document revision).

The information in this publication is believed to be accurate and reliable. However, no reponsibility is assumed by RM Micro Devices, inc. ("FRMD") for its use, nor for any infringement of patents, or other rights of third parties, resulting from its use. No license is granted by implication or otherwise under any patent or patent rights of RFMD. RFMD reserves the right to change component circuitry, recommended application circuitry and specifications at any time without prior notice.



RFMD Green: RoHS compliant per EU Directive 2011/65/EU, halogen free per IEC 61249-2-21, < 1000 ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

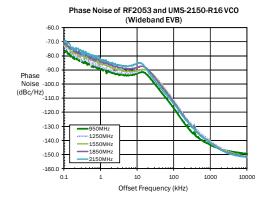
| Doromotor                              | 5                     | Specification | 1                     | Unit | Constitions                            |  |  |
|--|-----------------------|---------------|-----------------------|------|--|--|--|
| Parameter                              | Min.                  | Тур.          | Max.                  | Unit | Condition                              |  |  |
| ESD Requirements                       |                       | _             |                       |      |  |  |  |
| Human Body Model                       |                       |               |                       |      |  |  |  |
| General                                | 2000                  |               |                       | V    |  |  |  |
| RF Pins                                | 1000                  |               |                       | V    |  |  |  |
| Machine Model                          |                       |               |                       |      |  |  |  |
| General                                | 200                   |               |                       | V    |  |  |  |
| RF Pins                                | 100                   |               |                       | V    |  |  |  |
| Operating Conditions                   |                       |               |                       |      |  |  |  |
| Supply Voltage (V <sub>DD</sub> )      | 2.7                   | 3.0           | 3.6                   | V    |  |  |  |
| Temperature (T <sub>OP</sub> )         | -40                   |               | +85                   | °C   |  |  |  |
| Logic Inputs/Outputs                   |                       |               |                       |      | V <sub>DD</sub> =Supply to DIG_VDD pin |  |  |
| Input Low Voltage                      | -0.3                  |               | +0.5                  | V    |  |  |  |
| Input High Voltage                     | V <sub>DD /</sub> 1.5 |               | $V_{DD}$              | V    |  |  |  |
| Input Low Current                      | -10                   |               | +10                   | uA   | Input=0V                               |  |  |
| Input High Current                     | -10                   |               | +10                   | uA   | Input=V <sub>DD</sub>                  |  |  |
| Output Low Voltage                     | 0                     |               | 0.2 * V <sub>DD</sub> | V    |  |  |  |
| Output High Voltage                    | 0.8*V <sub>DD</sub>   |               | V <sub>DD</sub>       | V    |  |  |  |
| Load Resistance                        | 10                    |               |                       | kΩ   |  |  |  |
| Load Capacitance                       |                       |               | 20                    | pF   |  |  |  |
| Static                                 |                       |               |                       |      |  |  |  |
| Programmable Supply Current $(I_{DD})$ |                       |               |                       |      |  |  |  |
| Low Current Setting                    |                       | 50            |                       | mA   |  |  |  |
| High Linearity Setting                 |                       | 70            |                       | mA   |  |  |  |
| Standby                                |                       | 3             |                       | mA   | Reference oscillator and bandgap only. |  |  |
| Power Down Current                     |                       | 140           |                       | μΑ   | ENBL=0 and REF_STBY=0                  |  |  |
| Mixer                                  |                       |               |                       |      | Mixer output driving 4:1 balun.        |  |  |
| Gain                                   |                       | -2            |                       | dB   | Not including balun losses.            |  |  |
| Noise Figure                           |                       |               |                       |      |  |  |  |
| Low Current Setting                    |                       | 9.5           |                       | dB   |  |  |  |
| High Linearity Setting                 |                       | 12            |                       | dB   |  |  |  |

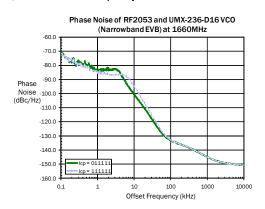


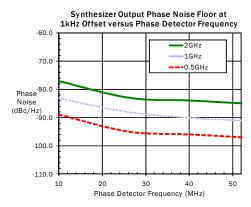
| Parameter  |      | Specification | n    | Unit              | Condition                       |
|--|------|---------------|------|-------------------|---------------------------------|
| - Parameter                                      | Min. | Тур.          | Max. | Unit              | Condition                       |
| Mixer, cont.                                     |      |               |      |                   |                                 |
| IIP3   |      |               |      |                   |                                 |
| Low Current Setting                              |      | +12           |      | dBm               |                                 |
| High Linearity Setting                           |      | +23           |      | dBm               |                                 |
| Pin1dB   |      |               |      |                   |                                 |
| Low Current Setting                              |      | +2            |      | dBm               |                                 |
| High Linearity Setting                           |      | +12           |      | dBm               |                                 |
| RF and IF Port Frequency Range                   | 30   |               | 2500 | MHz               |                                 |
| Mixer Input Return Loss                          |      | 10            |      | dB                | 100 $\Omega$ differential       |
| Voltage Controlled Oscillator Differential Input |      |               |      |                   |                                 |
| External VCO Input Frequency                     | 300  |               | 2400 | MHz               |                                 |
| External VCO Input Level                         | -6   | -3            | 0    | dBm               |                                 |
| Reference Oscillator                             |      | -             |      |                   |                                 |
| Xtal Frequency                                   | 10   |               | 52   | MHz               |                                 |
| External Reference Frequency                     | 10   |               | 104  | MHz               |                                 |
| Reference Divider Ratio                          | 1    |               | 7    |                   |                                 |
| External Reference Input Level                   | 500  | 800           | 1500 | mV <sub>P-P</sub> | AC-coupled                      |
| Local Oscillator                                 |      |               |      |                   |                                 |
| Synthesizer Output Frequency                     | 75   |               | 2400 | MHz               | At LO divider output            |
| Phase Detector Frequency                         |      |               | 52   | MHz               |                                 |
| Closed Loop Phase-Noise at 1kHz<br>Offset        |      |               |      |                   | 26 MHz phase detector frequency |
| 2 GHz LO Frequency                               |      | -85           |      | dBc/Hz            |                                 |
| 1GHz LO Frequency                                |      | -91           |      | dBc/Hz            |                                 |
| 500MHz LO Frequency                              |      | -97           |      | dBc/Hz            |                                 |
| Closed Loop Phase-Noise at<br>10 kHz Offset      |      |               |      |                   | 26 MHz phase detector frequency |
| 2 GHz LO Frequency                               |      | -90           |      | dBc/Hz            |                                 |
| 1GHz LO Frequency                                |      | -95           |      | dBc/Hz            |                                 |
| 500MHz LO Frequency                              |      | -102          |      | dBc/Hz            |                                 |
| Charge Pump                                      |      |               |      |                   |                                 |
| Charge Pump Current                              |      | 120           | 240  | μΑ                |                                 |
| Charge Pump Output Voltage                       | +0.7 | +1.1          | +1.5 | V                 |                                 |

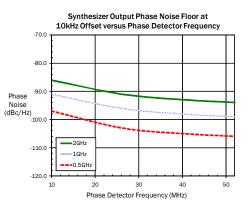


Typical Performance Characteristics for the RF2053 synthesizer  $V_{DD}=3V$ ,  $T_{\Delta}=25^{\circ}C$ , as measured on RF2053 evaluation board, Phase Detector Frequency=26MHz.

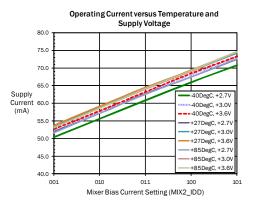






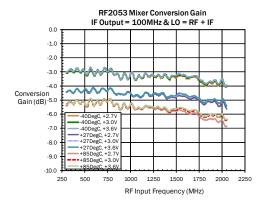


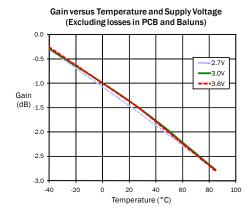
Typical Performance Characteristics for the RF2053

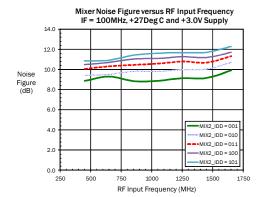


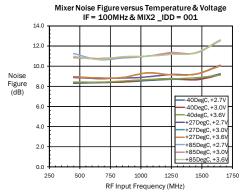


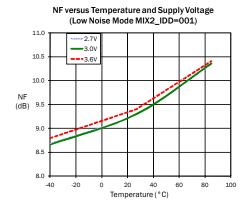
Typical Performance Characteristics for the RF2053 mixer  $V_{DD}$ =3V,  $T_{\Delta}$ =25°C, unless stated, as measured on RF2053 wideband evaluation board, Phase Detector Frequency=26MHz.

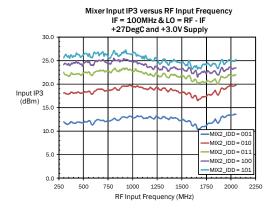






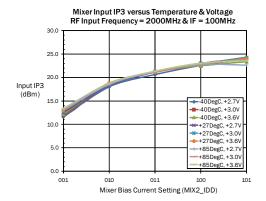


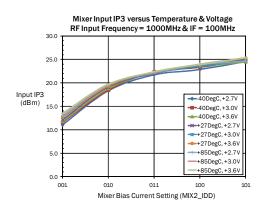


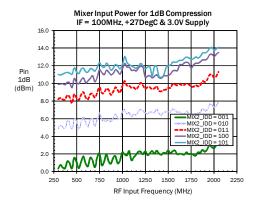


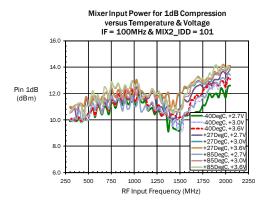


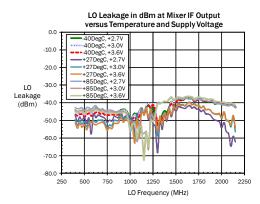
Typical Performance Characteristics for the RF2053 mixer  $V_{DD}=3V$ ,  $T_{\Delta}=25^{\circ}$ C, unless stated, as measured on RF2053 wideband evaluation board, Phase Detector Frequency=26MHz

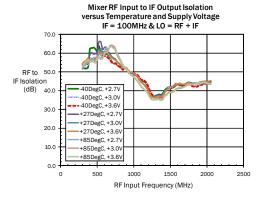














#### **Detailed Description**

The RF2053 is a wideband RF frequency converter chip which includes a fractional-N phase-locked loop, a crystal oscillator circuit, an LO buffer, and an RF mixer. The PLL operates with an external VCO. Synthesizer programming, device configuration and control are achieved through a mixture of hardware and software controls. All on-chip registers are programmed through a simple three-wire serial interface.

#### VCO

The RF2053 has been designed for use with an external VCO. The VCO inputs on pins 2 and 3 are differential.

In order to route the VCO input through buffers to the PLL divide circuits then CFG1:EXT\_VCO must be set high and the VCO control word must be set to VCO3, PLL2x0:P2\_VCOSEL=10.

The course tuning calibration (CT\_CAL) which is not used by the RF2053 should be disabled in order to minimize the PLL lock time. The VCO signal can be divided by 1, 2, or 4 in the LO divider circuit. The LO divide ratio is set by the PLL2x0:P2\_LODIV control words.

For applications where the required LO frequency is above 2GHz it is recommended that the LO buffer current be increased by setting CFG5:LO2\_I to 1100 (hex value C).

#### Fractional-N PLL

The IC contains a charge-pump based fractional-N phase locked loop (PLL) for controlling the external VCO. The PLL is intended to use a reference frequency signal of 10MHz to 104MHz. A reference divider (divide by 1 to divide by 7) is supplied and should be programmed to limit the frequency at the phase detector to a maximum of 52MHz. The reference divider bypass is controlled by bit CLK\_DIV\_BYP, set low to enable the reference divider and set high for divider bypass (divide by 1). The remaining three bits CLK\_DIV<15:13> set the reference divider value, divide by 2 (010) to 7 (111) when the reference divider is enabled.

Two PLL programming banks are provided, the first bank is preceded by the label PLL1 and the second bank is preceded by the label PLL2. For the RF2053 the default programming bank is PLL2, selected by setting the MODE pin high.

The PLL will lock the VCO to the frequency F<sub>VCO</sub> according to:

$$F_{VCO} = N_{EFF} * F_{OSC} / R$$

where  $N_{EFF}$  is the programmed fractional N divider value,  $F_{OSC}$  is the reference input frequency, and R is the programmed R divider value (1 to 7).

The N divider is a fractional divider, containing a dual-modulus prescaler and a digitally spur-compensated fractional sequence generator to allow fine frequency steps. The N divider is programmed using the N and NUM bits as follows:

First determine the desired, effective N divider value, N<sub>FFF</sub>:

N(9:0) should be set to the integer part of  $N_{EFF}$ . NUM should be set to the fractional part of  $N_{EFF}$  multiplied by  $2^{24} = 16777216$ .

Example: VCO operating at 2220 MHz, 23.92 MHz reference frequency, the desired effective divider value is:

$$N_{EFF} = F_{VCO} *R / F_{OSC} = 2220 *1 / 23.92 = 92.80936454895.$$

The N value is set to 92, equal to the integer part of  $N_{EFF}$ , and the NUM value is set to the fractional portion of  $N_{EFF}$  multiplied by  $2^{24}$ :

NUM=
$$0.80936454895 * 2^{24}=13.578.884$$
.

Converting N and NUM into binary results in the following:



N=0 0101 1100 NUM=1100 1111 0011 0010 1000 0100

So the registers would be programmed:

P2\_N=0 0101 1100 P2\_NUM\_MSB=1100 1111 0011 0010 P2\_NUM\_LSB=1000 0100

The maximum  $N_{EFF}$  is 511, and the minimum  $N_{EFF}$  is 15, when in fractional mode. The minimum step size is  $F_{OSC}/R \times 2^{24}$ . Thus for a 23.92 MHz reference, the frequency step size would be 1.4Hz. The minimum reference frequency that can be used is simply the maximum VCO frequency required divided by 511. For example for a VCO frequency of 2400 MHz, the minimum reference frequency, is 2400/511, 4.697 MHz (approx).

#### **Phase Detector and Charge Pump**

The chip provides a current output to drive an external loop filter. An external low noise operational amplifier can be used to design an active loop filter or a passive design can be implemented. This depends on the tuning range of the external VCO. The maximum charge pump output current is set by the value contained in the P2\_CP\_DEF field and CP\_LO\_I.

In the default state (P2\_CP\_DEF=31 and CP\_LO\_I=0) the charge pump current (ICPset) is 120uA. If CP\_LO\_I is set to 1 this current is reduced to 30uA. Note that lowest phase noise within the loop bandwidth is achieved with the maximum charge pump current.

The charge pump current can be altered by changing the value of P2\_CP\_DEF. The charge pump current is defined as:

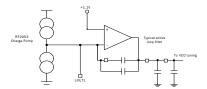
Changing the charge pump current will vary the loop filter response, higher current corresponding to a wider loop bandwidth.

The phase detector will operate with a maximum input frequency of 52MHz.

The loop filter calibration (KV\_CAL) is not used by the RF2053 and is disabled by default.

#### **Loop Filter**

The PLL may be designed to use an active or a passive loop filter as required. The active loop filter uses an external low noise op-amp. The CFG1:LF\_ACT bit is set low in both cases so that the internal op-amp is disabled and a high impedance is presented to the LFILT1 pin. The RF205x Programming Tool software can assist with loop filter designs. Because the op-amp is used in an inverting configuration in active mode, when the passive loop filter mode is selected the phase-detector polarity should be inverted. For active mode, CFG1:PDP=1, for passive mode, CFG1:PDP=0.



The charge pump output voltage compliance range is typically +0.7V to +1.5V. For applications using a passive loop filter the required VCO tuning voltage must fall within this voltage range under all conditions. When using an external op-amp as an integrator for the loop filter, as shown above, the non-inverting terminal should be referenced to +1.1V. This holds the charge pump output at this voltage in the center of its compliance range. The op-amp power supplies must be adequate to provide the necessary VCO tuning voltage.



#### **Crystal Oscillator**

The PLL may be used with an external reference source, or its own crystal oscillator. If an external source (such as a TCXO) is being used it should be AC-coupled into one of the XO inputs, and the other input should be AC-coupled to ground.

A crystal oscillator typically takes many milliseconds to settle, and so for applications requiring rapid pulsed operation of the PLL (such as a TDMA system, or Rx/Tx half-duplex system) it is necessary to keep the XO running between bursts. However, when the PLL is used less frequently, it is desirable to turn off the XO to minimize current draw. The REFSTBY register is provided to allow for either mode of operation. If REFSTBY is programmed high, the XO will continue to run even when ENBL is asserted low. Thus the XO will be stable and a clock is immediately available when ENBL is asserted high, allowing the chip to assume normal operation. On cold start, or if REFSTBY is programmed low, the XO will need a warm-up period before it can provide a stable clock. The length of this warm-up period will be dependant on the crystal characteristics.

The crystal oscillator circuit contains internal loading capacitors. No external loading capacitors are required, dependant on the crystal loading specification. The internal loading capacitors are a combination of fixed capacitance, and an array of switched capacitors. The switched capacitors can be used to tune the crystal oscillator onto the required center frequency and minimize frequency error. The PCB stray capacitance and oscillator input and output capacitance will also contribute to the crystal's total load capacitance. The register settings in the CFG4 register for the switched capacitors are as follows:

- Coarse Tune XO\_CT (4 bits) 15 \* 0.55 pF, default 0100
- Fine Step XO\_CR\_S (1 bit) 1\*0.25 pF, default 0

The on chip fixed capacitance is approximately 4.2 pF.

#### Wideband Mixer

The RF2053 includes a wideband, double-balanced Gilbert cell mixer. It supports RF/IF frequencies of 30MHz to 2500MHz. The mixer has an input port and an output port that can be used for either IF or RF, i.e. for up conversion or down conversion. The mixer current can be programmed to between 15mA and 35mA depending on linearity requirements, using the MIX-2\_IDD<3:0> word in the CFG2 register. The majority of the mixer current is sourced through the output pins via either a centre-tapped balun or an RF choke in the external matching circuitry to the supply.

The RF mixer input and output ports are differential and require simple matching circuits optimized to the specific application frequencies. A conversion gain of approximately -3dB to 0dB is achieved with  $100\Omega$  differential input impedance, and the outputs driving  $200\Omega$  differential load impedance. Increasing the mixer output load increases the conversion gain.

The mixer has a broadband common gate input. The input impedance is dominated by the resistance set by the mixer 1/gm term, which is inversely proportional to the mixer current setting. The resistance will be approximately  $85\Omega$  at the default mixer current setting (100). There is also some shunt capacitance at the mixer input, and the inductance of the bond wires to consider at higher frequencies.

The mixer output is high impedance, consisting of a resistance of approximately  $2k\Omega$  in parallel with some capacitance. The mixer output does not need to be matched as such, just to see a resistive load. A higher resistance load will give higher output voltage and gain. A shunt inductor can be used to resonate with the mixer output capacitance at the frequency of interest. This inductor may not be required at lower frequencies where the impedance of the output capacitance is less significant. At higher output frequencies the inductance of the bond wires becomes more significant.

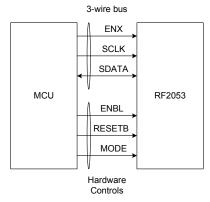
For more information about the mixer port impedances and matching, please refer to the RF205x Family Application Note on Matching Circuits and Baluns.



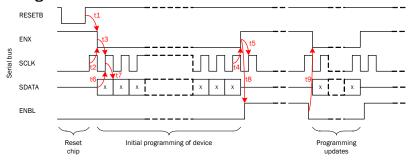
## **General Programming Information**

#### **Serial Interface**

All on-chip registers in the RF2053 are programmed using a 3-wire serial bus which supports both write and read operations. Synthesizer programming, device configuration and control are achieved through a mixture of hardware and software controls. Certain functions and operations require the use of hardware controls via the ENBL, MODE, and RESETB pins in addition to programming via the serial bus. For most applications the MODE pin can be held high.



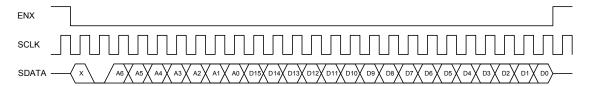
#### **Serial Data Timing Characteristics**



| Parameter | Description            | Time  |  |  |
|-----------|------------------------|-------|--|--|
| t1        | Reset delay            | >5 ns |  |  |
| t2        | Programming setup time | >5ns  |  |  |
| t3        | Programming hold time  | >5 ns |  |  |
| t4        | ENX setup time         | >5 ns |  |  |
| t5        | ENX hold time          | >5 ns |  |  |
| t6        | Data setup time        | >5ns  |  |  |
| t7        | Data hold time         | >5ns  |  |  |
| t8        | ENBL setup time        | >0ns  |  |  |
| t9        | ENBL hold time         | >0 ns |  |  |



#### Write



Initially ENX is high and SDATA is high impedance. The write operation begins with the controller starting SCLK. On the first falling edge of SCLK the baseband asserts ENX low. The second rising edge of SCLK is reserved to allow the SDI to initialize, and the third rising edge is used to define whether the operation will be a write or a read operation. In write mode the baseband will drive SDATA for the entire telegram. RF2053 will read the data bit on the rising edge of SCLK.

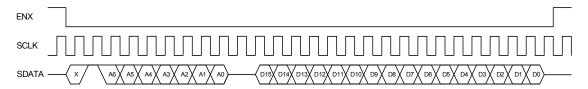
The next 7 data bits are the register address, MSB first. This is followed by the payload of 16 data bits for a total write mode transfer of 24 bits. Data is latched into RF2053 on the last rising edge of SCLK (after ENX is asserted high).

For more information, please refer to the timing diagram on page 12.

The maximum clock speed for a register write is 19.2 MHz. A register write therefore takes approximately 1.3 us. The data is latched on the rising edge of the clock. The datagram consists of a single start bit followed by a '0' (to indicate a write operation). This is then followed by a seven bit address and a sixteen bit data word.

Note that since the serial bus does not require the presence of the crystal clock, it is necessary to insert an additional rising clock edge before the ENX line is set low to ensure the address/data are read correctly.

#### Read



Initially ENX is high and SDATA is high impedance. The read operation begins with the controller starting SCLK. The controller is in control of the SDATA line during the address write operation. On the first falling edge of SCLK the baseband asserts ENX low. The second rising edge of SCLK is reserved to allow the SDI to initialize, and the third rising edge is used to define whether the operation will be a write or a read operation. In read mode the baseband will drive SDATA for the address portion of the telegram, and then control will be handed over to RF2053 for the data portion. RF2053 will read the data bits of the address on the rising edge of SCLK. After the address has been written, control of the SDATA line is handed over to RF2053. One and a half clocks are reserved for turn-around, and then the data bits are presented by RF2053. The data is set up on the rising edge of SCLK, and the controller latches the data on the falling edge of SCLK. At the end of the data transmission, RF2053 will release control of the SDATA line, and the controller asserts ENX high. The SDATA port on RF2053 transitions from high impedance to low impedance on the first rising edge of the data portion of the transaction (for example, 3 rising edges after the last address bit has been read), so the controller chip should be presenting a high impedance by that time.

For more information, please refer to the timing diagram on page 12.

The maximum clock speed for a register read is 19.2MHz. A register read therefore takes approximately 1.4us. The address is latched on the rising edge of the clock and the data output on the falling edge. The datagram consists of a single start bit fol-



lowed by a '1' (to indicate a read operation), followed by a seven bit address. A 1.5 bit delay is introduced before the sixteen bit data word representing the register content is presented to the receiver.

Note that since the serial bus does not require the presence of the crystal clock, it is necessary to insert an additional rising clock edge before the ENX line is set low to ensure the address is read correctly.

#### **Hardware Control**

Three hardware control pins are provided: ENBL, MODE, and RESETB.

#### **ENBL Pin**

The ENBL pin has two functions: to enable the analog circuits in the chip and to trigger the PLL to lock.

| ENBL Pin | REFSTBY Bit | XO and Bias Block | Analogue Block | Digital Block |
|----------|-------------|-------------------|----------------|---------------|
| Low      | 0           | Off               | Off            | On            |
| Low      | 1           | On                | Off            | On            |
| High     | 0           | On                | On             | On            |
| High     | 1           | On                | On             | On            |

Every time the frequency of the synthesizer is re-programmed, ENBL has to be taken high to initiate PLL locking.

#### **RESETB Pin**

The RESETB pin is a hardware reset control that will reset all digital circuits to their start-up state when asserted low. The device includes a power-on-reset function, so this pin should not normally be required, in which case it should be connected to the positive supply.

#### **MODE Pin**

The MODE pin controls which PLL programming register bank is active.

For normal operation of the RF2053 the MODE pin should be set high to select the default PLL2 programming registers. It is possible to set the FULLD bit in the CFG1 register high. This allows the MODE pin to select either PLL1 register bank (MODE=low) or PLL2 register bank (MODE=high). This may be useful for some applications where two LO frequencies can be programmed into the registers then the MODE pin used to toggle between them. The ENBL pin will also need to be cycled to relock the synthesizer for each frequency.

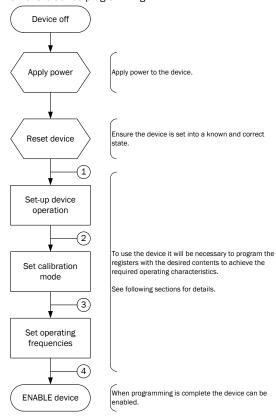


| Parameter | Description     | Time |  |  |  |
|-----------|-----------------|------|--|--|--|
| t1        | MODE setup time | >5ns |  |  |  |
| t2        | MODE hold time  | >5ns |  |  |  |



#### **Programming the RF2053**

The figure below shows an overview of the device programming.



Note: The set-up processes 1 to 2, 2 to 3, and 3 to 4 are explained further below.

Additional information on device use and programming can be found on the RF205x family page of the RFMD web site (http://www.rfmd.com/rf205x). The following documents may be particularly helpful:

- RF205x Frequency Synthesizer User Guide
- RF205x Calibration User Guide



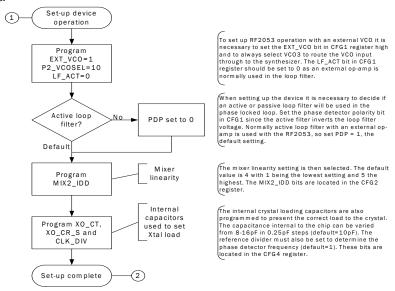
#### Start-up

When starting up and following device reset then REFSTBY=0, REFSTBY should be asserted high approximately 500ecs. before ENBL is taken high. This is to allow the XO to settle and will depend on XO characteristics. After taking ENBL high there is typically 20 usecs for the PLL state machine and charge pump to initialize, the VCO warm-up state, before PLL locking starts. The time spent in the VCO warm-up state is set by CFG1:TVCO, which should be set to 00111 when using a 26 MHz clock. Following the warm-up period there will be the additional time taken for the PLL to settle to the required frequency. All of these timings will be dependent upon application specific factors such as loop filter bandwidth, reference clock frequency, and XO characteristics. The fastest turn-on and lock time will be obtained by leaving REFSTBY asserted high, disabling all calibration routines (always the case for the RF2053), minimizing the VCO warm-up time, and setting the PLL loop bandwidth as wide as possible.

The device can be reset into its initial state (default settings) at any time by performing a hard reset. This is achieved by setting the RESETB pin low for at least 100ns.

#### **Setting Up Device Operation**

The device offers a number of operating modes which need to be set up in the device before it will work as intended. This is achieved as follows.

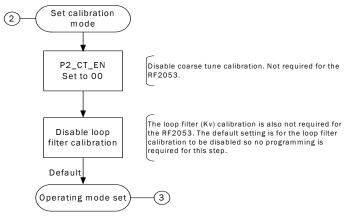


Three registers need to be written, taking 3.9us at the maximum clock speed.



#### **Disabling Calibration**

The VCO coarse tune calibration should be disabled as it is not used on the RF5203. The loop filter calibration, also unused, is disabled by default.

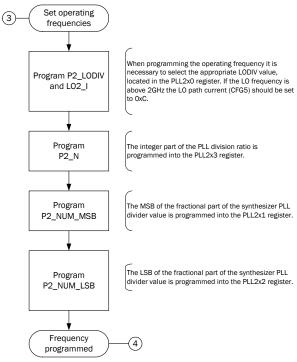


One register needs to be written taking 1.3 us at maximum clock speed. Since it is necessary to program this register when setting the operating frequency (see next section) this operation usually carries no overhead.



#### **Setting The Operating Frequency**

Setting the operating frequency of the device requires a number of registers to be programmed.



A total of four registers must be programmed to set the device operating frequency. This will take 5.2 us for each path at maximum clock speed.

To change the frequency of the VCO it will be necessary to repeat these operations. However, if the frequency shift is small it may not be necessary to reprogram all the bits reducing the number of register writes to three.

For an example on how to determine the integer and fractional parts of the synthesizer PLL division ratio please refer to the detailed description of the PLL on page 9.



## **Programming Registers**

## **Register Map Diagram**

| Reg.    | g. R/W Add Data |     |             |              |       |                 |                 |     |      |                 |        |                 |                       |              |                 |         |         |         |
|---------|-----------------|-----|-------------|--------------|-------|-----------------|-----------------|-----|------|-----------------|--------|-----------------|-----------------------|--------------|-----------------|---------|---------|---------|
| Name    | ry w            | Auu | 15          | 14           | 13    | 12              | 11              | 10  | 9    | 8               | 7      | 6               | 5                     | 4            | 3               | 2       | 1       | 0       |
| CFG1    | R/W             | 00  | LD_EN       | LD_LEV       |       |                 | TVCO            |     |      | PDP             | LF_ACT | -               | CPL                   | CT_POL       | Res             | EXT_VCO | FULLD   | CP_LO_I |
| CFG2    | R/W             | 01  | M           | IX1_IDD      |       | MIX1            | 1_VB            | MI  | X2_I | DD              | MIX2   | _VB             | Res                   | KV_RNG       | NBR             | CT_AVG  | NBR_F   | (V_AVG  |
| CFG3    | R/W             | 02  |             | TKV1         |       |                 |                 | TK  | V2   |                 |        |                 | Res                   |              | FL              | L_FACT  | CT_CPOL | REFSTBY |
| CFG4    | R/W             | 03  | CLI         | K_DIV_BY     | /PASS | 3               |                 | XO_ | CT   |                 | XO_I2  | XO_I1           | XO_CR_S               |              |                 | TCT     |         | •       |
| CFG5    | R/W             | 04  |             | L01_I        |       |                 |                 | LO  | 2_I  |                 |        |                 |                       | T_PH_        | ALGN            | l       |         |         |
| CFG6    | R/W             | 05  |             |              |       |                 | SU_W            | _   |      |                 |        |                 |                       |              |                 | Res     |         |         |
| PLL1x0  | R/W             | 08  | P1_V        | COSEL        |       | CT_E<br>N       | P1_F            |     |      | _LO-<br>)IV     | Re     | es              |                       |              | P1_             | CP_DEF  |         |         |
| PLL1x1  | R/W             | 09  |             |              |       |                 |                 |     |      |                 | P1_N   | IUM_M           | SB                    |              |                 |         |         |         |
| PLL1x2  | R/W             | OA  |             | - 1          | P1_N  | UM_L            | SB              |     |      |                 |        |                 | P                     | 1_CT_DE      | =               |         |         | Res     |
| PLL1x3  | R/W             | OB  |             |              |       | P1              | _N              |     |      |                 |        |                 | Res                   | S            | P1_VCOI         |         |         |         |
| PLL1x4  | R/W             | OC  |             |              |       | P1_             | _DN             |     |      |                 |        |                 | P1_CT_GAIN P1_KV_GAIN |              |                 | AIN     | Res     |         |
| PLL1x5  | R/W             | OD  |             |              |       |                 | PHS_/           | _   |      |                 |        |                 | Res                   | Res P1_CT_V  |                 |         |         |         |
| PLL2x0  | R/W             | 10  | P2_V        | COSEL        |       | CT_E<br>N       | P2_K<br>N       |     |      | _LO-<br>)IV     | Re     | es              | P2_CP_DEF             |              |                 |         |         |         |
| PLL2x1  | R/W             | 11  |             |              |       |                 |                 |     |      |                 | P2_N   | P2_NUM_MSB      |                       |              |                 |         |         |         |
| PLL2x2  | R/W             | 12  |             | - 1          | P2_N  | UM_L            | SB              |     |      |                 |        |                 | P2_CT_DEF             |              |                 |         | Res     |         |
| PLL2x3  | R/W             | 13  |             |              |       | P2              | 2_N             |     |      |                 |        |                 | Res                   |              |                 | P2_VCOI |         |         |
| PLL2x4  | R/W             | 14  |             |              |       | P2_             | _DN             |     |      |                 |        |                 | P2_CT_GAIN P2_KV_GAIN |              |                 | AIN     | Res     |         |
| PLL2x5  | R/W             | 15  |             |              |       |                 | PHS_/           | ADJ |      |                 |        |                 | Res                   |              |                 | P2_CT_  | _V      |         |
| GPO     | R/W             | 18  | Res         | P1_G-<br>P01 | Res   | P1_<br>GP0<br>3 | P1_<br>GPO<br>4 |     |      | Res             |        | P2_G-<br>P01    | Res                   | P2_G-<br>P03 | P2_<br>GP0<br>4 |         | Res     |         |
| CHIPREV | R               | 19  | PARTNO      |              |       |                 |                 |     |      |                 | REVNO  |                 |                       |              |                 |         |         |         |
| RB1     | R               | 1C  | LOCK CT_CAL |              |       |                 |                 |     |      |                 |        |                 | CP_CAL Res            |              |                 |         | es      |         |
| RB2     | R               | 1D  | VO_CAL      |              |       |                 |                 |     |      |                 |        | V1_CAL          |                       |              |                 |         |         |         |
| RB3     | R               | 1E  | RSM_STATE   |              |       |                 |                 |     |      |                 | Res    |                 |                       |              | ·               |         |         |         |
| TEST    | R               | 1F  | TEN TMUX    |              |       |                 | CPU             | CPD | FNZ  | LDO<br>_BY<br>P | TSEL   | Res DACTEST Res |                       |              | Res             |         |         |         |



## CFG1 (00h) - Operational Configuration Parameters

| #  | Bit Name  | Default |   | Function   |
|----|-----------|---------|---|--|
| 15 | LD_EN     | 1       | 9 | Enable lock detector circuitry   |
| 14 | LD_LEV    | 0       |   | Modify lock range for lock detector  |
| 13 | TVCO(4:0) | 0       |   | VCO warm-up time =TVCO/(F <sub>REF</sub> * 256)  |
| 12 |           | 0       |   |  |
| 11 |           | 0       | 1 |  |
| 10 |           | 0       |   |  |
| 9  |           | 0       |   |  |
| 8  | PDP       | 1       |   | Phase detector polarity: 0=positive, 1=negative  |
| 7  | LF_ACT    | 1       | С | Active loop filter enable, 1=Active 0=Passive  |
| 6  | CPL(1:0)  | 1       |   | Charge pump leakage current: 00=no leakage, 01=low leakage, 10=mid leakage, 11=high  |
| 5  |           | 0       |   | leakage  |
| 4  | CT_POL    | 0       |   | Polarity of VCO coarse-tune word: 0=positive, 1=negative   |
| 3  |           | 0       | 0 |  |
| 2  | EXT_VCO   | 0       |   | Set to 1=external VCO (VCO3 disabled, KV_CAL and CT_CAL must be disabled)  |
| 1  | FULLD     | 0       |   | 0=Half duplex, mixer is enabled according to MODE pin, 1=Full duplex, both mixers enabled. For RF2053 setting FULLD high gives access to both PLL register banks using MODE pin. |
| 0  | CP_LO_I   | 0       |   | 0=High charge pump current, 1=low charge pump current  |

## CFG2 (01h) - Mixer Bias and PLL Calibration

| #  | Bit Name   | Default |   | Function   |
|----|------------|---------|---|--|
| 15 | MIX1_IDD   | 1       | 8 | This register is not used for the RF2053.                                      |
| 14 |            | 0       |   |  |
| 13 |            | 0       |   |  |
| 12 | MIX1_VB    | 0       |   | This register is not used for the RF2053.                                      |
| 11 |            | 1       | С |  |
| 10 | MIX2_IDD   | 1       |   | Mixer 2 current setting: 000=0mA to 111=35mA in 5mA steps                      |
| 9  |            | 0       |   |  |
| 8  |            | 0       |   |  |
| 7  | MIX2_VB    | 0       | 5 | Mixer 2 voltage bias   |
| 6  |            | 1       |   |  |
| 5  |            | 0       |   |  |
| 4  | KV_RNG     | 1       |   | Sets accuracy of voltage measurement during KV calibration: 0=8 bits, 1=9 bits |
| 3  | NBR_CT_AVG | 1       | 8 | Number of averages during CT cal   |
| 2  |            | 0       |   |  |
| 1  | NBR_KV_AVG | 0       |   | Number of averages during KV cal   |
| 0  |            | 0       |   |  |



## CFG3 (02h) - PLL Calibration

| #  | Bit Name | Default |   | Function  |
|----|----------|---------|---|---|
| 15 | TKV1     | 0       | 0 | Settling time for first measurement in LO KV compensation                                 |
| 14 |          | 0       |   |   |
| 13 |          | 0       |   |   |
| 12 |          | 0       |   |   |
| 11 | TKV2     | 0       | 4 | Settling time for second measurement in LO KV compensation                                |
| 10 |          | 1       |   |   |
| 9  |          | 0       |   |   |
| 8  |          | 0       |   |   |
| 7  |          | 0       | 0 |   |
| 6  |          | 0       |   |   |
| 5  |          | 0       |   |   |
| 4  |          | 0       |   |   |
| 3  | FLL_FACT | 0       | 4 | Default setting 01. Needs to be set to 00 for N<28. This case can arise when higher phase |
| 2  |          | 1       | 1 | detector frequencies are used.  |
| 1  | CT_CPOL  | 0       | ] |   |
| 0  | REFSTBY  | 0       | ] | Reference oscillator standby mode 0=X0 is off in standby mode, 1=X0 is on in standby mode |

## CFG4 (O3h) - Crystal Oscillator and Reference Divider

| #  | Bit Name       | Def | ault | Function  |
|----|----------------|-----|------|---|
| 15 | CLK_DIV        | 0   | 1    | Reference divider, divide by 2 (010) to 7 (111) when reference divider is enabled |
| 14 |                | 0   |      |   |
| 13 |                | 0   |      |   |
| 12 | CLK_DIV_BYPASS | 1   |      | Reference divider enabled=0, divider bypass (divide by 1)=1                       |
| 11 | XO_CT          | 1   | 8    | Crystal oscillator coarse tune (approximately 0.5 pF steps from 8 pF to 16 pF)    |
| 10 |                | 0   |      |   |
| 9  |                | 0   |      |   |
| 8  |                | 0   |      |   |
| 7  | X0_I2          | 0   | 0    | Crystal oscillator current setting  |
| 6  | XO_I1          | 0   |      |   |
| 5  | XO_CR_S        | 0   |      | Crystal oscillator additional fixed capacitance (approximately 0.25pF)            |
| 4  | TCT            | 0   |      | Duration of coarse tune acquisition   |
| 3  |                | 1   | F    |   |
| 2  |                | 1   |      |   |
| 1  |                | 1   |      |   |
| 0  |                | 1   |      |   |



## CFG5 (04h) - LO Bias

| #  | Bit Name  | Def | ault | Function                               |
|----|-----------|-----|------|--|
| 15 | L01_I     | 0   | 0    | Local oscillator Path1 current setting |
| 14 |           | 0   |      |  |
| 13 |           | 0   |      |  |
| 12 |           | 0   |      |  |
| 11 | L02_I     | 0   | 0    | Local oscillator Path2 current setting |
| 10 |           | 0   |      |  |
| 9  |           | 0   |      |  |
| 8  |           | 0   |      |  |
| 7  | T_PH_ALGN | 0   | 0    | Phase alignment timer                  |
| 6  |           | 0   |      |  |
| 5  |           | 0   |      |  |
| 4  |           | 0   |      |  |
| 3  |           | 0   | 4    |  |
| 2  | 1         | 1   | 1    |  |
| 1  |           | 0   | ]    |  |
| 0  | 1         | 0   | 1    |  |

## CFG6 (05h) - Start-up Timer

| #  | Bit Name | Def | ault | Function                           |
|----|----------|-----|------|------------------------------------|
| 15 | SU_WAIT  | 0   | 0    | Crystal oscillator settling timer. |
| 14 |          | 0   |      |                                    |
| 13 |          | 0   |      |                                    |
| 12 |          | 0   |      |                                    |
| 11 |          | 0   | 1    |                                    |
| 10 |          | 0   |      |                                    |
| 9  |          | 0   |      |                                    |
| 8  |          | 1   |      |                                    |
| 7  |          | 0   | 0    |                                    |
| 6  |          | 0   |      |                                    |
| 5  |          | 0   |      |                                    |
| 4  |          | 0   |      |                                    |
| 3  |          | 0   | 0    |                                    |
| 2  |          | 0   |      |                                    |
| 1  |          | 0   | 1    |                                    |
| 0  |          | 0   |      |                                    |



## PLL1x0 (08h) - VCO, LO Divider and Calibration Select

| #  | Bit Name  | Def | ault | Function   |
|----|-----------|-----|------|--|
| 15 | P1_VCOSEL | 0   | 7    | Path 1 VCO band select: 00=VCO1, 01=VCO2, 10=VCO3, 11=Reserved                               |
| 14 |           | 1   | 1    | Always set to 10 for VCO3.   |
| 13 | P1_CT_EN  | 1   | 1    | Path 1 VCO coarse tune: 00=disabled, 11=enabled  |
| 12 |           | 1   | 1    | Set to 00 to disable VCO coarse tune.  |
| 11 | P1_KV_EN  | 0   | 1    | Path 1 VCO tuning gain calibration: 00=disabled, 11=enabled                                  |
| 10 |           | 0   | 1    | Set to 00 to disable calibration.  |
| 9  | P1_LODIV  | 0   | 1    | Path 1 local oscillator divider: 00=divide by 1, 01=divide by 2, 10=divide by 4, 11=reserved |
| 8  |           | 1   |      |  |
| 7  |           | 0   | 1    |  |
| 6  |           | 0   | 1    |  |
| 5  | P1_CP_DEF | 0   | 1    | Charge pump current setting  |
| 4  |           | 1   | 1    | If P1_KV_EN=11 this value sets charge pump current during KV compensation only               |
| 3  |           | 1   | F    |  |
| 2  | 1         | 1   | 1    |  |
| 1  | 1         | 1   | 1    |  |
| 0  |           | 1   | 1    |  |

## PLL1x1 (09h) - MSB of Fractional Divider Ratio

| #  | Bit Name   | Def | ault | Function   |
|----|------------|-----|------|--|
| 15 | P1_NUM_MSB | 0   | 6    | Path 1 VCO divider numerator value, most significant 16 bits |
| 14 |            | 1   |      |  |
| 13 |            | 1   |      |  |
| 12 |            | 0   |      |  |
| 11 |            | 0   | 2    |  |
| 10 |            | 0   |      |  |
| 9  |            | 1   |      |  |
| 8  |            | 0   |      |  |
| 7  |            | 0   | 7    |  |
| 6  |            | 1   |      |  |
| 5  |            | 1   |      |  |
| 4  |            | 1   |      |  |
| 3  |            | 0   | 6    |  |
| 2  |            | 1   | 1    |  |
| 1  | 1          | 1   | 1    |  |
| 0  |            | 0   | 1    |  |



## PLL1x2 (0Ah) - LSB of Fractional Divider Ratio and CT Default

| #  | Bit Name   | Def | ault | Function   |
|----|------------|-----|------|--|
| 15 | P1_NUM_LSB | 0   | 2    | Path 1 VCO divider numerator value, least significant 8 bits |
| 14 |            | 0   |      |  |
| 13 |            | 1   |      |  |
| 12 |            | 0   |      |  |
| 11 |            | 0   | 7    |  |
| 10 |            | 1   |      |  |
| 9  |            | 1   |      |  |
| 8  |            | 1   |      |  |
| 7  | P1_CT_DEF  | 0   | 7    | Path 1 VCO coarse tuning value, not required for RF2053.     |
| 6  |            | 1   |      |  |
| 5  |            | 1   |      |  |
| 4  |            | 1   |      |  |
| 3  |            | 1   | E    |  |
| 2  | 1          | 1   | 1    |  |
| 1  | 1          | 1   | 1    |  |
| 0  |            | 0   | 1    |  |

## PLL1x3 (0Bh) - Integer Divider Ratio and VCO Current

| #  | Bit Name | Def | ault | Function  |
|----|----------|-----|------|---|
| 15 | P1_N     | 0   | 2    | Path 1 VCO divider integer value                              |
| 14 |          | 0   |      |   |
| 13 |          | 1   |      |   |
| 12 |          | 0   |      |   |
| 11 |          | 0   | 3    |   |
| 10 |          | 0   |      |   |
| 9  |          | 1   |      |   |
| 8  |          | 1   |      |   |
| 7  |          | 0   | 0    |   |
| 6  |          | 0   |      |   |
| 5  |          | 0   |      |   |
| 4  |          | 0   |      |   |
| 3  |          | 0   | 2    |   |
| 2  | P1_VCOI  | 0   |      | Path 1 VCO bias setting: 000=minimum value, 111=maximum value |
| 1  |          | 1   |      |   |
| 0  | 1        | 0   |      |   |



## PLL1x4 (0Ch) - Calibration Settings

| #  | Bit Name   | Def | ault | Function   |
|----|------------|-----|------|--|
| 15 | P1_DN      | 0   | 1    | Path 1 frequency step size used in VCO tuning gain calibration |
| 14 |            | 0   |      |  |
| 13 |            | 0   |      |  |
| 12 |            | 1   |      |  |
| 11 |            | 0   | 7    |  |
| 10 |            | 1   |      |  |
| 9  |            | 1   |      |  |
| 8  |            | 1   |      |  |
| 7  |            | 1   | E    |  |
| 6  | P1_CT_GAIN | 1   |      | Path 1 coarse tuning calibration gain                          |
| 5  |            | 1   |      |  |
| 4  |            | 0   |      |  |
| 3  | P1_KV_GAIN | 0   | 4    | Path 1 VCO tuning gain calibration gain                        |
| 2  |            | 1   |      |  |
| 1  |            | 0   |      |  |
| 0  |            | 0   |      |  |

## PLL1x5 (0Dh) - More Calibration Settings

|    | D'I Nove     | D. ( | - 11 | F e   |
|----|--------------|------|------|---|
| #  | Bit Name     | Det  | ault | Function  |
| 15 | P1_N_PHS_ADJ | 0    | 0    | Path 1 frequency step size used in VCO tuning gain calibration                              |
| 14 |              | 0    |      |   |
| 13 |              | 0    |      |   |
| 12 |              | 0    |      |   |
| 11 |              | 0    | 0    |   |
| 10 |              | 0    |      |   |
| 9  |              | 0    |      |   |
| 8  |              | 0    |      |   |
| 7  |              | 0    | 1    |   |
| 6  |              | 0    |      |   |
| 5  |              | 0    |      |   |
| 4  | P1_CT_V      | 1    |      | Path 1 course tuning voltage setting when performing course tuning calibration. Not used by |
| 3  |              | 0    | 0    | RF2053.   |
| 2  |              | 0    |      |   |
| 1  |              | 0    |      |   |
| 0  |              | 0    |      |   |



## PLL2x0 (10h) - VCO, LO Divider and Calibration Select

| #  | Bit Name  | Def | ault | Function   |
|----|-----------|-----|------|--|
| 15 | P2_VCOSEL | 0   | 7    | Path 2 VCO band select: 00=VCO1, 01=VCO2, 10=VCO3, 11=Reserved.                              |
| 14 |           | 1   |      | Always set to 10 for VCO3.   |
| 13 | P2_CT_EN  | 1   |      | Path 2 VCO coarse tune: 00=disabled, 11=enabled.   |
| 12 |           | 1   |      | Set to 00 to disable VCO coarse tune.  |
| 11 | P2_KV_EN  | 0   | 1    | Path 2 VCO tuning gain calibration: 00=disabled, 11=enabled.                                 |
| 10 |           | 0   |      | Set to 00 to disable calibration.  |
| 9  | P2_LODIV  | 0   |      | Path 2 local oscillator divider: 00=divide by 1, 01=divide by 2, 10=divide by 4, 11=reserved |
| 8  |           | 1   |      |  |
| 7  |           |     | 1    |  |
| 6  |           |     |      |  |
| 5  | P2_CP_DEF | 0   |      | Charge pump current setting.   |
| 4  |           | 1   |      | If P2_KV_EN=11 this value sets charge pump current during KV compensation only               |
| 3  |           | 1   | F    |  |
| 2  |           | 1   |      |  |
| 1  |           | 1   |      |  |
| 0  | 1         | 1   |      |  |

## PLL2x1 (11h) - MSB of Fractional Divider Ratio

| #  | Bit Name   | Def | ault | Function   |
|----|------------|-----|------|--|
| 15 | P2_NUM_MSB | 0   | 6    | Path 2 VCO divider numerator value, most significant 16 bits |
| 14 |            | 1   | 1    |  |
| 13 |            | 1   |      |  |
| 12 |            | 0   |      |  |
| 11 |            | 0   | 2    |  |
| 10 |            | 0   |      |  |
| 9  |            | 1   |      |  |
| 8  |            | 0   |      |  |
| 7  |            | 0   | 7    |  |
| 6  |            | 1   |      |  |
| 5  |            | 1   |      |  |
| 4  |            | 1   |      |  |
| 3  |            | 0   | 6    |  |
| 2  |            | 1   |      |  |
| 1  |            | 1   |      |  |
| 0  |            | 0   |      |  |



## PLL2x2 (12h) - LSB of Fractional Divider Ratio and CT Default

| #  | Bit Name   | Def | ault | Function  |
|----|------------|-----|------|---|
| 15 | P2_NUM_LSB | 0   | 2    | Path 2 VCO divider numerator value, least significant 8 bits. |
| 14 |            | 0   |      |   |
| 13 |            | 1   |      |   |
| 12 |            | 0   |      |   |
| 11 |            | 0   | 7    |   |
| 10 |            | 1   |      |   |
| 9  |            | 1   |      |   |
| 8  |            | 1   |      |   |
| 7  | P2_CT_DEF  | 0   | 7    | Path 2 VCO coarse tuning value. Not required for RF2053.      |
| 6  |            | 1   |      |   |
| 5  |            | 1   |      |   |
| 4  |            | 1   |      |   |
| 3  |            | 1   | E    |   |
| 2  |            | 1   |      |   |
| 1  |            | 1   |      |   |
| 0  |            | 0   |      |   |

## PLL2x3 (13h) - Integer Divider Ratio and VCO Current

| #  | Bit Name | Def | ault | Function  |
|----|----------|-----|------|---|
| 15 | P2_N     | 0   | 2    | Path 2 VCO divider integer value                              |
| 14 |          | 0   |      |   |
| 13 |          | 1   |      |   |
| 12 |          | 0   |      |   |
| 11 |          | 0   | 3    |   |
| 10 |          | 0   |      |   |
| 9  |          | 1   |      |   |
| 8  |          | 1   |      |   |
| 7  |          | 0   | 0    |   |
| 6  |          | 0   |      |   |
| 5  |          | 0   |      |   |
| 4  |          | 0   |      |   |
| 3  |          | 0   | 2    |   |
| 2  | P2_VCOI  | 0   | ]    | Path 1 VCO bias setting: 000=minimum value, 111=maximum value |
| 1  |          | 1   | ]    |   |
| 0  | 1        | 0   | 1    |   |



## PLL2x4 (14h) - Calibration Settings

| #  | Bit Name   | Def | ault | Function   |
|----|------------|-----|------|--|
| 15 | P2_DN      | 0   | 1    | Path 2 frequency step size used in VCO tuning gain calibration |
| 14 |            | 0   |      |  |
| 13 |            | 0   |      |  |
| 12 |            | 1   |      |  |
| 11 |            | 0   | 7    |  |
| 10 |            | 1   |      |  |
| 9  |            | 1   |      |  |
| 8  |            | 1   |      |  |
| 7  |            | 1   | E    |  |
| 6  | P2_CT_GAIN | 1   |      | Path 2 coarse tuning calibration gain                          |
| 5  |            | 1   |      |  |
| 4  |            | 0   |      |  |
| 3  | P2_KV_GAIN | 0   | 4    | Path 2 VCO tuning gain calibration gain                        |
| 2  | 1          | 1   |      |  |
| 1  | 1          | 0   |      |  |
| 0  |            | 0   |      |  |

## PLL2x5 (15h) - More Calibration Settings

| #  | Bit Name     | Def | ault | Function  |
|----|--------------|-----|------|---|
| 15 | P2_N_PHS_ADJ | 0   | 0    | Path 2 synthesizer phase adjustment   |
| 14 |              | 0   |      |   |
| 13 |              | 0   |      |   |
| 12 |              | 0   |      |   |
| 11 |              | 0   | 0    |   |
| 10 |              | 0   |      |   |
| 9  |              | 0   |      |   |
| 8  |              | 0   |      |   |
| 7  |              | 0   | 1    |   |
| 6  |              | 0   |      |   |
| 5  |              | 0   |      |   |
| 4  | P2_CT_V      | 1   |      | Path 2 course tuning voltage setting when performing course tuning calibration. Not used by |
| 3  |              | 0   | 0    | RF2053.   |
| 2  | 1            | 0   |      |   |
| 1  | 1            | 0   |      |   |
| 0  |              | 0   |      |   |



## **GPO (18h) - Internal Control Output Settings**

| #  | Bit Name | De | fault | Function  |
|----|----------|----|-------|---|
| 15 |          | 0  | 0     |   |
| 14 | P1_GP01  | 0  |       | Setting of GPO1 when path 1 is active, used internally only |
| 13 |          | 0  |       |   |
| 12 | P1_GP03  | 0  |       | Setting of GPO3 when path 1 is active, used internally only |
| 11 | P1_GP04  | 0  | 0     | Setting of GPO4 when path 1 is active, used internally only |
| 10 |          | 0  |       |   |
| 9  |          | 0  |       |   |
| 8  |          | 0  |       |   |
| 7  |          | 0  | 0     |   |
| 6  | P2_GP01  | 0  |       | Setting of GPO1 when path 2 is active, used internally only |
| 5  |          | 0  |       |   |
| 4  | P2_GP03  | 0  |       | Setting of GPO3 when path 2 is active, used internally only |
| 3  | P2_GP04  | 0  | 0     | Setting of GPO4 when path 2 is active, used internally only |
| 2  |          | 0  |       |   |
| 1  |          | 0  |       |   |
| 0  |          | 0  |       |   |

## **CHIPREV (19h) - Chip Revision Information**

| #  | Bit Name | Def | ault | Function                    |
|----|----------|-----|------|-----------------------------|
| 15 | PARTNO   | 0   | 0    | RFMD Part number for device |
| 14 |          | 0   |      |                             |
| 13 |          | 0   |      |                             |
| 12 |          | 0   |      |                             |
| 11 |          | 0   | 0    |                             |
| 10 |          | 0   |      |                             |
| 9  |          | 0   |      |                             |
| 8  |          | 0   |      |                             |
| 7  | REVNO    | Х   | Х    | Part revision number        |
| 6  |          | X   |      |                             |
| 5  |          | Х   |      |                             |
| 4  |          | Х   |      |                             |
| 3  |          | X   | Х    |                             |
| 2  |          | X   |      |                             |
| 1  | 1        | Х   |      |                             |
| 0  | 1        | Χ   |      |                             |



## RB1 (1Ch) - PLL Lock and Calibration Results Read-back

| #  | Bit Name | Def | ault | Function                               |
|----|----------|-----|------|--|
| 15 | LOCK     | Х   | X    | PLL lock detector, not used by RF2053. |
| 14 | CT_CAL   | Х   |      | CT setting, not used by RF2053.        |
| 12 |          | X   |      |  |
| 11 |          | Х   | Х    |  |
| 10 |          | Х   | 1    |  |
| 9  |          | Χ   | 1    |  |
| 8  |          | X   | 1    |  |
| 7  | CP_CAL   | Х   | Х    | CP setting, not used by RF2053.        |
| 5  |          | X   |      |  |
| 4  |          | X   |      |  |
| 3  |          | X   | Х    |  |
| 2  |          | Χ   | 1    |  |
| 1  |          | 0   | 1    |  |
| 0  |          | 0   | 1    |  |

#### **RB2 (1Dh) - Calibration Results Read-Back**

| #  | Bit Name | Def | ault | Function   |
|----|----------|-----|------|--|
| 15 | VO_CAL   | Х   | Χ    | The VCO voltage measured at the start of a VCO gain calibration. Not used by RF2053. |
| 14 |          | X   |      |  |
| 13 |          | X   |      |  |
| 12 |          | Х   |      |  |
| 11 |          | Х   | Х    |  |
| 10 |          | X   |      |  |
| 9  |          | Х   |      |  |
| 8  |          | Χ   |      |  |
| 7  | V1_CAL   | X   | Χ    | The VCO voltage measured at the end of a VCO gain calibration. Not used by RF2053.   |
| 6  |          | X   |      |  |
| 5  |          | X   |      |  |
| 4  |          | Χ   |      |  |
| 3  |          | X   | Х    |  |
| 2  |          | Χ   |      |  |
| 1  |          | X   |      |  |
| 0  |          | Χ   |      |  |



## RB3 (1Eh) - PLL state Read-Back

| #  | Bit Name  | De | fault | Function                         |
|----|-----------|----|-------|----------------------------------|
| 15 | RSM_STATE | Х  | X     | State of the radio state machine |
| 14 |           | Х  |       |                                  |
| 13 |           | Χ  |       |                                  |
| 12 |           | Х  |       |                                  |
| 11 |           | Х  | Х     |                                  |
| 10 |           | Χ  |       |                                  |
| 9  |           | 0  |       |                                  |
| 8  |           | 0  |       |                                  |
| 7  |           | 0  | 0     |                                  |
| 6  |           | 0  |       |                                  |
| 5  |           | 0  |       |                                  |
| 4  |           | 0  |       |                                  |
| 3  |           | 0  | 0     |                                  |
| 2  |           | 0  | 1     |                                  |
| 1  |           | 0  | 1     |                                  |
| 0  |           | 0  |       |                                  |

## TEST (1Fh) - Test Modes

| #  | Bit Name | De | fault | Function   |
|----|----------|----|-------|--|
| 15 | TEN      | 0  | 0     | Enables test mode  |
| 14 | TMUX     | 0  |       | Sets test multiplexer state                                  |
| 13 |          | 0  |       |  |
| 12 |          | 0  |       |  |
| 11 | CPU      | 0  | 0     | Set charge pump to pump up, 0=normal operation 1=pump down   |
| 10 | CPD      | 0  |       | Set charge pump to pump down, 0=normal operation 1=pump down |
| 9  | FNZ      | 0  |       | 0=normal operation, 1=fractional divider modulator disabled  |
| 8  | LDO_BYP  | 0  |       | On chip low drop out regulator bypassed                      |
| 7  | TSEL     | 0  | 0     |  |
| 6  |          | 0  |       |  |
| 5  |          | 0  |       |  |
| 4  | DACTEST  | 0  |       | DAC test   |
| 3  |          | 0  | 0     |  |
| 2  |          | 0  |       |  |
| 1  |          | 0  |       |  |
| 0  |          | 0  |       |  |

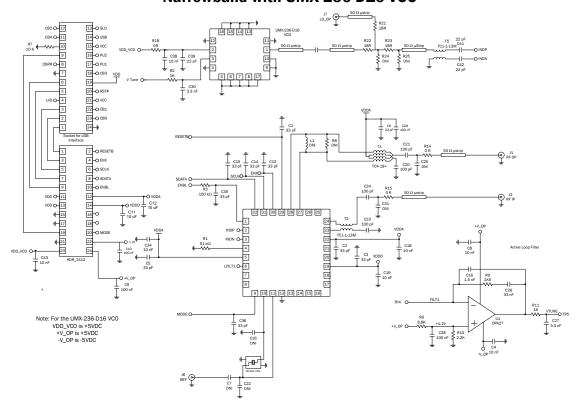


#### **Evaluation Board**

The following diagrams show the schematic and PCB layout of the RF2053 evaluation boards. The standard evaluation board, DK2053, has been configured with a narrowband VCO covering 1646MHz to 1670MHz. The wideband evaluation board, DK2053-WB, has a VCO covering over an octave, 950MHz to 2150MHz. The mixer input and output on both boards have been configured for broadband oeration. Application notes have been produced showing how the device is matched and on balun implementations for narrowband applications. The evaluation boards are provided as part of a design kit (DK2053 and DK2053-WB), along with the necessary cables and programming software tool to enable full evaluation of the RF2053.

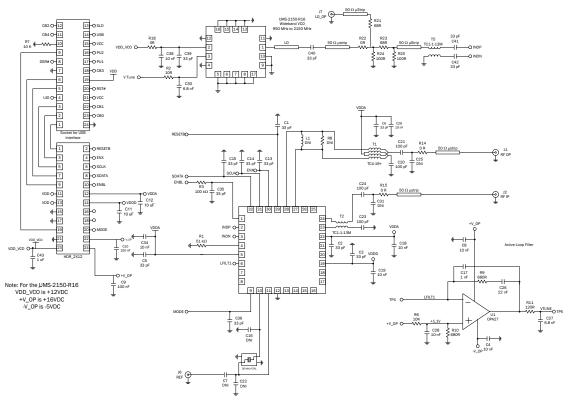


# Evaluation Board Schematic Narrowband with UMX-236-D16 VCO





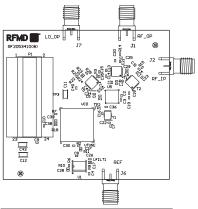
#### Wideband with UMS-2150-R16 VCO

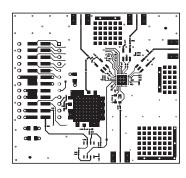


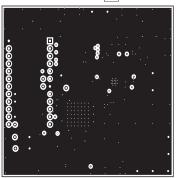


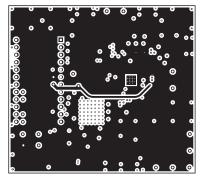
# Evaluation Board Layout Board Size 2.5" x 2.5"

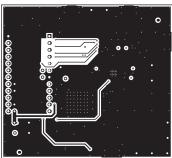
Board Thickness 0.040", Board Material FR-4





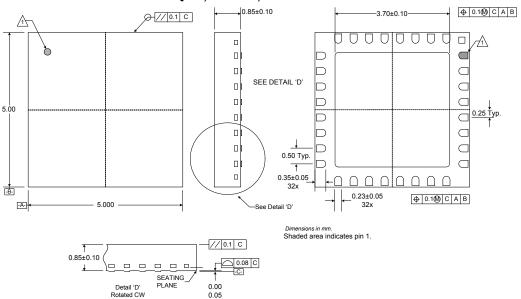








# Package Drawing QFN, 32-Pin, 5mmx5mm



## **Support and Applications Information**

Application notes and support material can be downloaded from the product web page: www.rfmd.com/rf205x.

## **Ordering Information**

| Part Number | Package  | Quantity         |  |  |  |
|-------------|--|------------------|--|--|--|
| RF2053      | 32-Pin QFN   | 25pcs sample bag |  |  |  |
| RF2053SB    | 32-Pin QFN   | 5pcs sample bag  |  |  |  |
| RF2053SR    | 32-Pin QFN   | 100pcs reel      |  |  |  |
| RF2053TR7   | 32-Pin QFN   | 750pcs reel      |  |  |  |
| RF2053TR13  | 32-Pin QFN   | 2500pcs reel     |  |  |  |
| DK2053      | Complete Design Kit<br>Narrowband VCO Evaluation Board | 1 box            |  |  |  |
| DK2053WB    | Complete Design Kit<br>Wideband VCO Evaluation Board   | 1 box            |  |  |  |



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